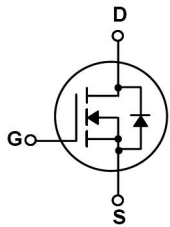


/ Descriptions

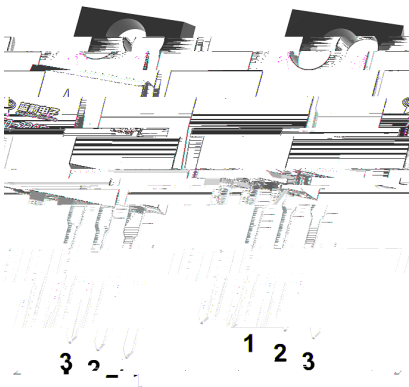
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



/ Marking

BRFL25N50



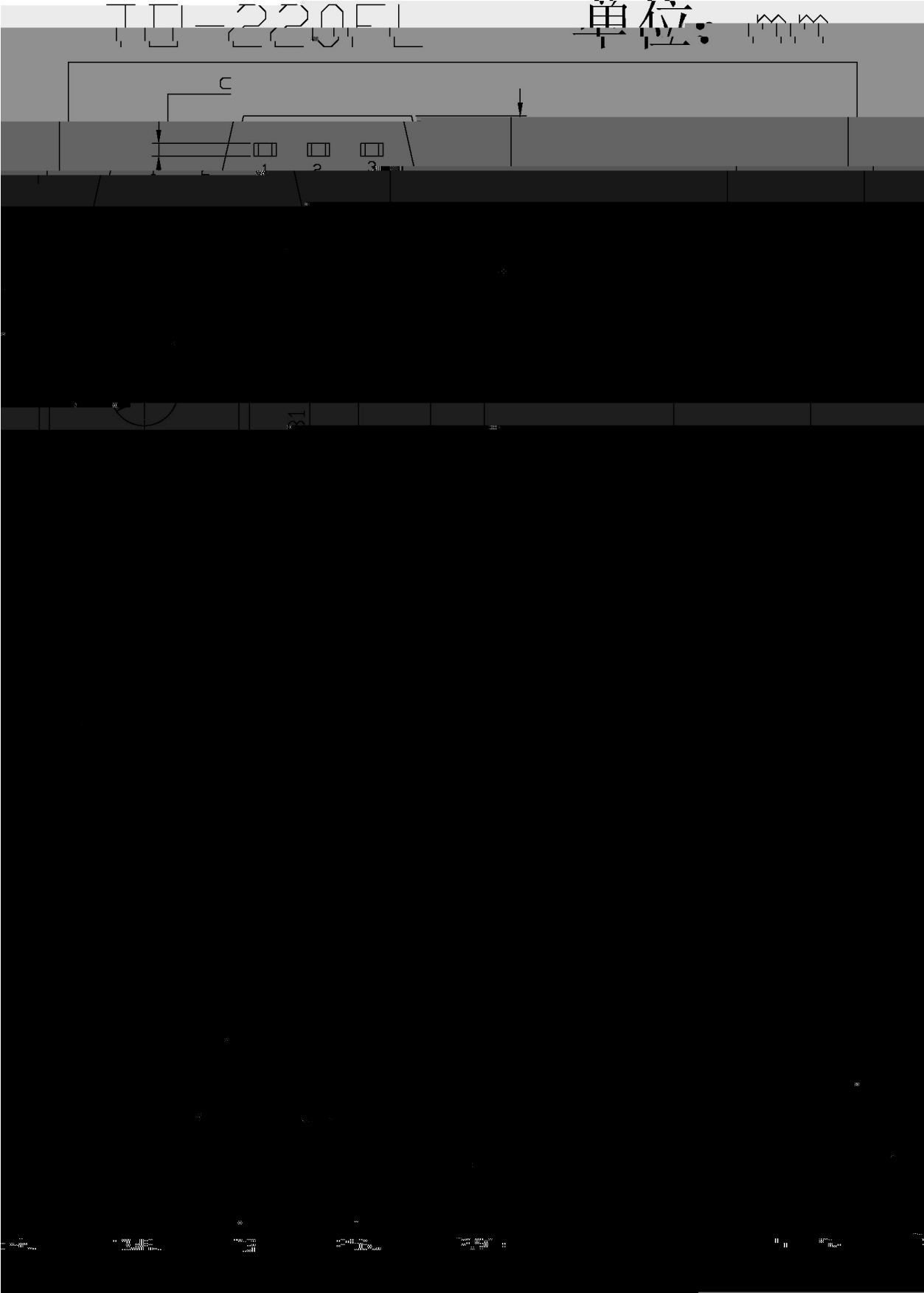
DATA SHEET

BRFL25N50

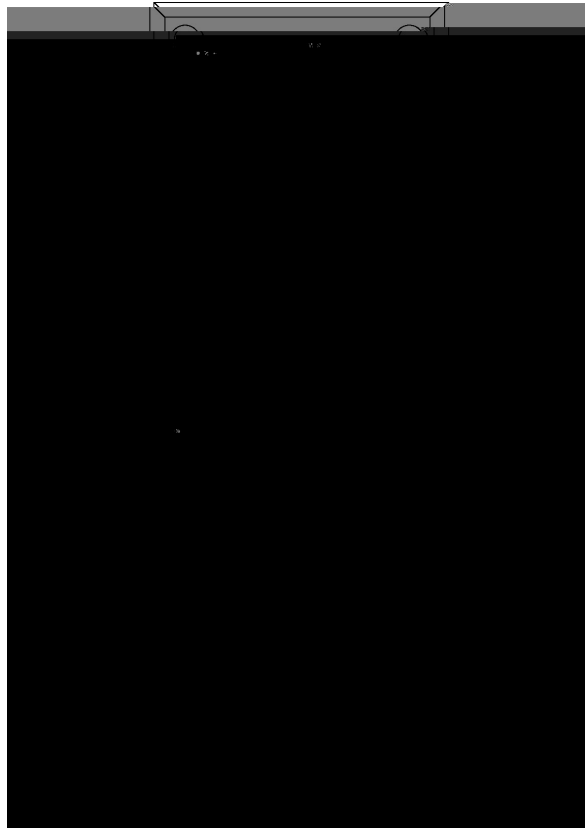


DATA SHEET

/ Package Dimensions



/ Marking Instructions



0
32 H H B26
H 0 H B26
H

BRFL25N50



DATA SHEET

() / Temperature Profile for Dip Soldering(Pb-Free)

/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

7>B E

; >B fH

; >B p .